

INFORMATION DISCLOSURE STATEMENT

Applicant : Tomohide BANBA et al.
App. No : 10/565,565
Filed : January 23, 2006
For : AN INORGANIC POWDER-CONTAINING RESIN
COMPOSITION, A FILM-FORMING MATERIAL
LAYER, A TRANSFER SHEET, METHOD OF
PRODUCING A SUBSTRATE HAVING A DIELECTRIC
LAYER FORMED THEREON, AND A SUBSTRATE
HAVING A DIELECTRIC LAYER FORMED THEREON
Examiner : SZEKELY, Peter A.
Art Unit : 1796

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 7 references to be considered by the Examiner. Also enclosed are 5 foreign patent references and/or non-patent literature as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing date of a Notice of Allowance.


CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(1)

I hereby certify that each item of information contained in this Statement was first cited in a communication from a foreign Patent Office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

Thus, no fee is required as set forth in 37 C.F.R. § 1.97(c), however, the Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

Respectfully submitted,
KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 21-Nov-07

By: 
Kerry Taylor
Registration No. 43,947
Attorney of Record
Customer No. 20,995
(619) 235-8550